



Features

- Bidirectional TVS 3.3 V
- Low capacitance - 13 pF
- ESD protection 15 kV
- 0402 DFN package
- RoHS compliant*

Applications

- Computers and peripherals
- Communication systems
- Audio & video equipment
- Portable instrumentation
- Handheld portable devices

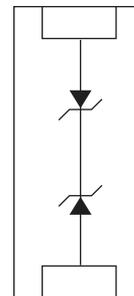
CDDFN2-T3.3B - Surface Mount TVS Diode

General Information

The Bourns® Model CDDFN2-T3.3B low capacitance device provides ESD, EFT and surge protection for external ports of electronic devices such as cellular phones, handheld electronics and other portable electronic devices.

The device measures 1.0 mm x 0.60 mm x 0.55 mm and is available in a DFN-2 package intended to be mounted directly onto an FR4 printed circuit board. The device will fit a 0402 footprint.

The device is designed to meet IEC 61000-4-2 (ESD), IEC 61000-4-4 (EFT) and IEC61000-4-5 (Surge) protection requirements.



Maximum Ratings (@ T_A = 25 °C Unless Otherwise Noted)

Parameter	Symbol	Value	Unit
Storage Temperature	T _{STG}	-55 to +150	°C
Operating Temperature	T _{OPR}	-55 to +85	°C
ESD Protection per IEC 61000-4-2	Contact Discharge	15	kV
	Air Discharge	15	kV
EFT Protection per IEC 61000-4-4 (5/50 ns)	EFT	50	A
Peak Pulse Current per IEC 61000-4-5 (8/20 μs)	I _{pp}	5	A

Electrical Characteristics (@ T_A = 25 °C Unless Otherwise Noted)

Parameter	Symbol	Min.	Typ.	Max.	Unit
Working Peak Voltage	V _{WM}	-3.3		3.3	V
Breakdown Voltage @ 1 mA	V _{BR}	4		6.5	V
Leakage Current @ 3.3 V	I _L		0.1	1.0	μA
Capacitance @ 0 V, 1 MHz	C _J		13.5	16.5	pF
Clamping Voltage @ I _{pp} = 5 A, 8/20 μs	V _C		6.5	8	V

BOURNS®

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*RoHS Directive 2002/95/EC Jan. 27, 2003 including annex and RoHS Recast 2011/65/EU June 8, 2011.

Specifications are subject to change without notice.

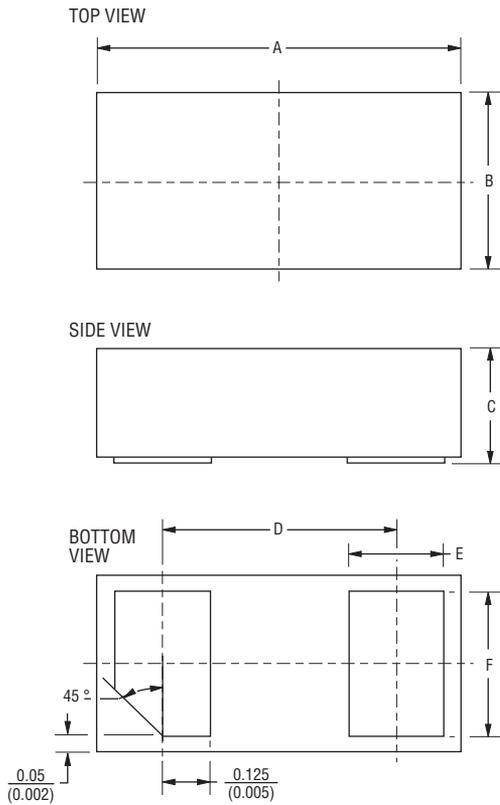
The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time. Users should verify actual device performance in their specific applications.

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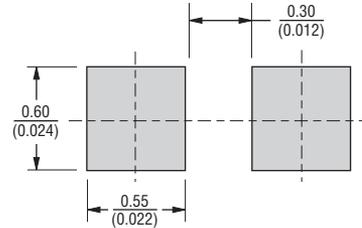


Product Dimensions

This is a Molded DFN-2 package with lead free 100 % Sn plating on the terminations. It weighs approximately 30 mg.



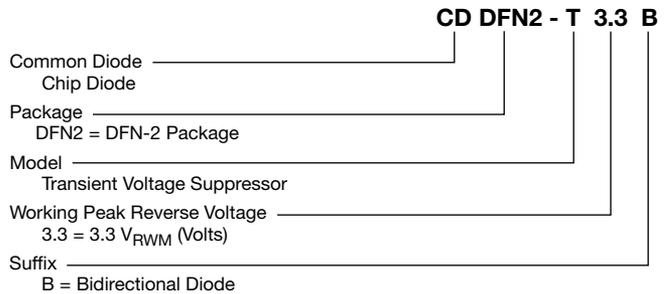
Recommended PCB Footprint



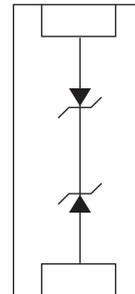
Typical Part Marking

CDDFN2-T3.3B Y

How to Order



Block Diagram



Symbol	Dimensions		
	Min.	Nom.	Max.
A	$\frac{0.95}{(0.037)}$	$\frac{1.00}{(0.039)}$	$\frac{1.05}{(0.041)}$
B	$\frac{0.55}{(0.022)}$	$\frac{0.60}{(0.024)}$	$\frac{0.65}{(0.026)}$
C	$\frac{0.41}{(0.016)}$	$\frac{0.45}{(0.018)}$	$\frac{0.50}{(0.020)}$
D	$\frac{0.65}{(0.026)}$		
E	$\frac{0.20}{(0.008)}$	$\frac{0.25}{(0.010)}$	$\frac{0.30}{(0.012)}$
F	$\frac{0.45}{(0.018)}$	$\frac{0.50}{(0.020)}$	$\frac{0.55}{(0.022)}$

DIMENSIONS: $\frac{\text{MM}}{\text{(INCHES)}}$

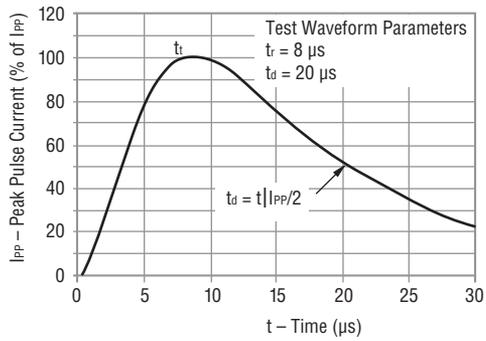
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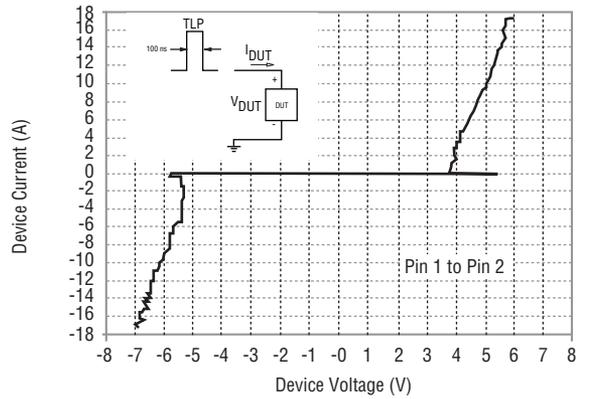
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Performance Graphs

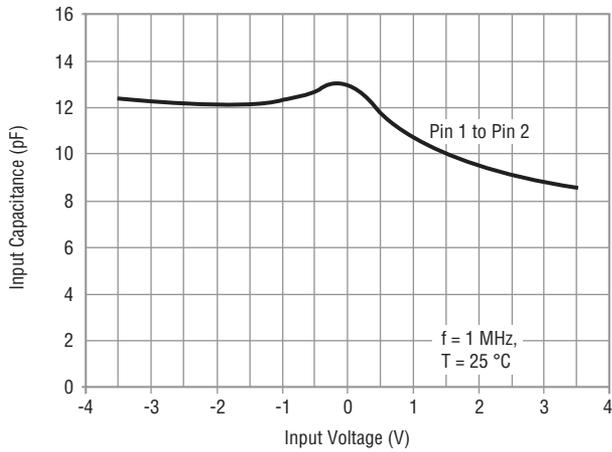
Pulse Waveform



TLP I-V Plot



Typical Capacitance Variation of C_{IN} vs V_{IN}



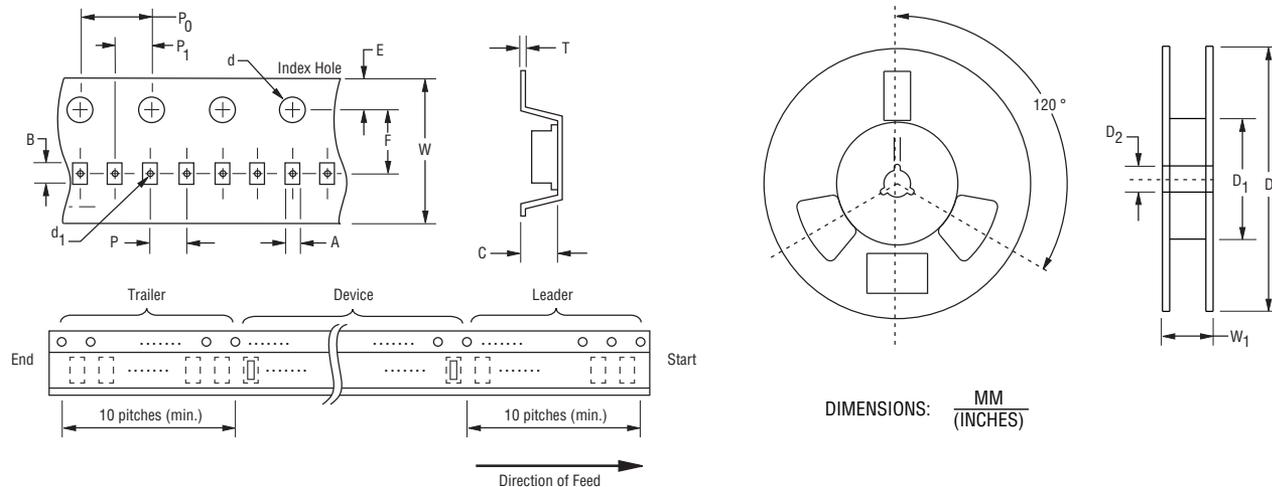
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Packaging Information

The surface mount product is packaged in an 8 mm x 4 mm tape and reel format per EIA-481 standard.



DIMENSIONS: $\frac{\text{MM}}{\text{(INCHES)}}$

Item	Symbol	DFN-2
Carrier Width	A	$\frac{0.70 \pm 0.05}{(0.028 \pm 0.002)}$
Carrier Length	B	$\frac{1.15 \pm 0.05}{(0.045 \pm 0.002)}$
Carrier Depth	C	$\frac{0.47 \pm 0.05}{(0.019 \pm 0.002)}$
Sprocket Hole	d	$\frac{1.55 \pm 0.05}{(0.061 \pm 0.002)}$
Reel Outside Diameter	D	$\frac{179.0 \pm 1.00}{(7.05 \pm 0.04)}$
Punch Hole	d ₁	$\frac{0.4 \pm 0.05}{0.016 \pm 0.002}$
Reel Inner Diameter	D ₁	$\frac{60.0 \pm 0.50}{2.362 \pm 0.02}$
Feed Hole Diameter	D ₂	$\frac{13.0 \pm 0.20}{(0.512 \pm 0.008)}$
Sprocket Hole Position	E	$\frac{1.75 \pm 0.10}{(0.069 \pm 0.004)}$
Punch Hole Position	F	$\frac{3.50 \pm 0.05}{(0.138 \pm 0.002)}$
Punch Hole Pitch	P	$\frac{2.00 \pm 0.05}{(0.079 \pm 0.002)}$
Sprocket Hole Pitch	P ₀	$\frac{4.00 \pm 0.10}{(0.157 \pm 0.004)}$
Embossment Center	P ₁	$\frac{2.00 \pm 0.05}{(0.079 \pm 0.002)}$
Overall Tape Thickness	T	$\frac{0.20 \pm 0.05}{(0.008 \pm 0.002)}$
Tape Width	W	$\frac{8.00 \pm 0.10}{(0.315 \pm 0.004)}$
Reel Width	W ₁	$\frac{14.4}{(0.567)} \text{ MAX.}$
Quantity per Reel	--	12,000

REV. 10/31/13

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В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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